

**Description:**

Powerex Mosfet modules are designed for use in switching applications. Each Module consists of sixteen mosfets, and four diodes in an asymmetrical half bridge configuration. All components are potted in a sealed chamber and are electrically isolated from the heat sinking base plate, offering simplified system assembly and thermal management.

Features:

- ◆ Low Drive Power
- ◆ Isolated baseplate for easy heat sinking
- ◆ High Capacity Diodes (D3 & D4)
- ◆ Massively Parallelized Mosfets
- ◆ Low rDS on
- ◆ Free wheel diodes
- ◆ Package can be modified to suit customer specifications

Applications:

- ◆ Switching Power Supplies
- ◆ Switching Amplifiers
- ◆ Motion/Servo Control

Ordering Information:

Contact Powerex Custom Modules



QJP0910001

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Asymmetrical Half Bridge
100 Amperes/900 Volts**Maximum Ratings, Tc=25°C unless otherwise specified**

Symbol	Parameter	Conditions	Ratings	Units
V _{DSS}	Drain-Source Voltage	V _{GS} =0V	900	Volts
V _{GSS}	Gate Source Voltage	V _{DS}	±30	Volts
I _D	Drain Current		100	Amperes
I _{DM}	Drain Current (Pulsed)		336	Amperes
I _F	Forward current D3, D4	TC=25°C	150	Amperes
I _{FM}	Forward surge current D3, D4	Pulse	300	Amperes
V _{iso}	Isolation Voltage	Main terminal to Base, AC for 1 minute	2500	Volts
T _{ch}	Channel Temperature		-55 ~ +150	°C

Electrical Characteristics, Tch=25°C unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Units
V(BR) DSS	Drain-source breakdown voltage	Id=8mA, VGS=0V	900	-	-	V
V(BR)GSS	Gate-source breakdown voltage	IGS=±800µA, VDS=0V	±30	-	-	V
I _{GSS}	Gate leakage current	VGS=±25V, VDS=0V	-	-	±80	µA
I _{DSS}	Drain Current	VDS=900V, VGS=0V	-	-	8	mA
V _{GS(th)}	Gate-source threshold voltage	ID=8mA, vds=10V	2	3	4	Volts
rDS (ON)	Gate-source on-state resistance	Id=56A, vgs=10V	-	.078	.106	Ω
V _{DS} (ON)	Drain-source on-state voltage	Id=56A, VGS=10V	-	4.41	5.95	Volts
V _F	Diode forward voltage D3,D4	IF=150A			3.5	Volts
C _{ISS}	Input capacitance	VDS=25V, VGS=0V, F=1MHz	.023			µF
C _{OSS}	Output capacitance		.002			µF
C _{RSS}	Reverse transfer capacitance		400			pF
V _{SD}	Source – Drain Voltage	Is= 56A, VGS=0V		1.0	1.5	Volts
R _{th (ch-c)}	Thermal Resistance	Per mosfet	-	0.031		°C/W
R _{th (jc)}	Thermal Resistance	Per diode	-	0.095		°C/W